



May 13, 2006

To: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Serial No.	10/796,427	03/09/04
MOU-SHIUNG LIN		
"WIREBOND PAD FOR SEMICONDUCTOR CHIP OR WAFER"		
Grp. Art Unit: 2822	LEWIS, MONICA	

RESPONSE TO FINAL OFFICE ACTION

Dear Sir:

In response to the Office Action mailed Mar. 13, 2006, please consider the remarks as follows:

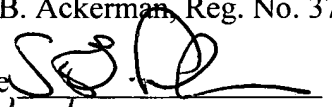
CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 15, 2006.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date


5/15/06